

2N5655 Datasheet



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DiGi Electronics Part Number	2N5655-DG
Manufacturer	onsemi
Manufacturer Product Number	2N5655
Description	TRANS NPN 250V 0.5A TO126
Detailed Description	Bipolar (BJT) Transistor NPN 250 V 500 mA 10MHz 2 0 W Through Hole TO-126

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Purchase and inquiry

Manufacturer Product Number:	Manufacturer:
2N5655	onsemi
Series:	Product Status:
	Obsolete
Transistor Type:	Current - Collector (Ic) (Max):
NPN	500 mA
Voltage - Collector Emitter Breakdown (Max):	Vce Saturation (Max) @ lb, lc:
250 V	10V @ 100mA, 500mA
Current - Collector Cutoff (Max):	DC Current Gain (hFE) (Min) @ lc, Vce:
100µA	30 @ 100mA, 10mV
Power - Max:	Frequency - Transition:
20 W	10MHz
Operating Temperature:	Mounting Type:
-65°C ~ 150°C (TJ)	Through Hole
Package / Case:	Supplier Device Package:
TO-225AA, TO-126-3	TO-126
Base Product Number:	
2N5655	

Environmental & Export classification

RoHS Status:	Moisture Sensitivity Level (MSL):
RoHS non-compliant	1 (Unlimited)
REACH Status:	ECCN:
REACH Unaffected	EAR99
HTSUS:	
8541.29.0095	

2N5655G, 2N5657G

Plastic NPN Silicon High-Voltage Power Transistors

These devices are designed for use in line–operated equipment such as audio output amplifiers; low–current, high–voltage converters; and AC line relays.

Features

- Excellent DC Current Gain
- High Current–Gain Bandwidth Product
- These Devices are Pb-Free and are RoHS Compliant*

MAXIMUM RATINGS (Note 1)

Rating	Symbol	Value	Unit
Collector–Emitter Voltage 2N5655G 2N5657G	V _{CEO}	250 350	Vdc
Collector–Base Voltage 2N5655G 2N5657G	V _{CB}	275 375	Vdc
Emitter-Base Voltage	V _{EB}	6.0	Vdc
Collector Current – Continuous	Ι _C	0.5	Adc
Collector Current – Peak	I _{CM}	1.0	Adc
Base Current	I _B	1.0	Adc
Total Device Dissipation @ T _C = 25°C Derate above 25°C	P _D	20 0.16	W W/°C
Operating and Storage Junction Temperature Range	T _J , T _{stg}	-65 to +150	°C/W

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Indicates JEDEC registered data.

THERMAL CHARACTERISTICS

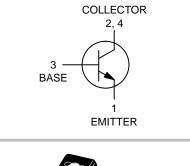
Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction-to-Case	R_{\thetaJC}	6.25	°C/W



ON Semiconductor®

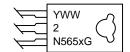
http://onsemi.com

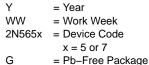
0.5 AMPERE POWER TRANSISTORS NPN SILICON 250–350 VOLTS, 20 WATTS





MARKING DIAGRAM





ORDERING INFORMATION

De	vice	Package	Shipping
2N56	55G	TO–225 (Pb–Free)	500 Units / Bulk
2N56	57G	TO-225 (Pb-Free)	500 Units / Bulk

*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

2N5655G, 2N5657G

ELECTRICAL CHARACTERISTICS ($T_C = 25^{\circ}C$ unless otherwise noted) (Note 2)

Characteristic	Symbol	Min	Max	Unit
OFF CHARACTERISTICS				
Collector–Emitter Sustaining Voltage (I _C = 100 mAdc (inductive), L = 50 mH) 2N5655G 2N5657G	V _{CEO(sus)}	250 350		Vdc
Collector–Emitter Breakdown Voltage $(I_C = 1.0 \text{ mAdc}, I_B = 0)$ 2N5655G 2N5657G	V _{(BR)CEO}	250 350		Vdc
Collector Cutoff Current $(V_{CE} = 150 \text{ Vdc}, I_B = 0)$ 2N5655G $(V_{CE} = 250 \text{ Vdc}, I_B = 0)$ 2N5657G	ICEO	-	0.1 0.1	mAdc
	ICEX	- - -	0.1 0.1 1.0 1.0	mAdc
Collector Cutoff Current $(V_{CB} = 275 \text{ Vdc}, I_E = 0)$ 2N5655G $(V_{CB} = 375 \text{ Vdc}, I_E = 0)$ 2N5657G	Ісво	-	10 10	μAdc
Emitter Cutoff Current ($V_{EB} = 6.0 \text{ Vdc}, I_C = 0$)	I _{EBO}	_	10	μAdc
ON CHARACTERISTICS				
DC Current Gain (Note 3) ($I_C = 50 \text{ mAdc}, V_{CE} = 10 \text{ Vdc}$) ($I_C = 100 \text{ mAdc}, V_{CE} = 10 \text{ Vdc}$) ($I_C = 250 \text{ mAdc}, V_{CE} = 10 \text{ Vdc}$) ($I_C = 500 \text{ mAdc}, V_{CE} = 10 \text{ Vdc}$)	h _{FE}	25 30 15 5.0	_ 250 _ _	_
	V _{CE(sat)}	- - -	1.0 2.5 10	Vdc
Base–Emitter Voltage (I _C = 100 mAdc, V _{CE} = 10 Vdc) (Note 3)	V _{BE}	_	1.0	Vdc
DYNAMIC CHARACTERISTICS	1		1	1
Current–Gain – Bandwidth Product ($I_C = 50 \text{ mAdc}, V_{CE} = 10 \text{ Vdc}, f = 10 \text{ MHz}$) (Note 4)	fT	10	_	MHz
Output Capacitance $(V_{CB} = 10 \text{ Vdc}, I_E = 0, f = 100 \text{ kHz})$	C _{ob}	-	25	pF
Small–Signal Current Gain ($I_C = 100 \text{ mAdc}, V_{CE} = 10 \text{ Vdc}, f = 1.0 \text{ kHz}$)	h _{fe}	20	_	-

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics for the listed test conditions. 2. Indicates JEDEC registered data for 2N5655 Series. 3. Pulse Test: Pulse Width \leq 300 µs, Duty Cycle \leq 2.0%. 4. f_T is defined as the frequency at which $|h_{fe}|$ extrapolates to unity.

2N5655G, 2N5657G

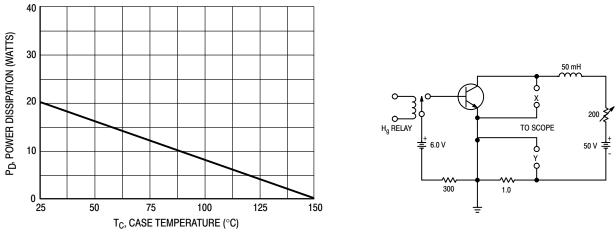
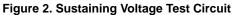


Figure 1. Power Derating



Safe Area Limits are indicated by Figures 3 and 4. Both limits are applicable and must be observed.

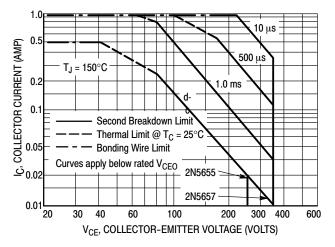


Figure 3. Active-Region Safe Operating Area

There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate $I_C - V_{CE}$ limits of the transistor that must be observed for reliable operation; i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

The data of Figure 3 is based on $T_{J(pk)} = 150^{\circ}$ C; T_{C} is variable depending on conditions. Second breakdown pulse limits are valid for duty cycles to 10% provided $T_{J(pk)} \le 150^{\circ}$ C. At high case temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by second breakdown.

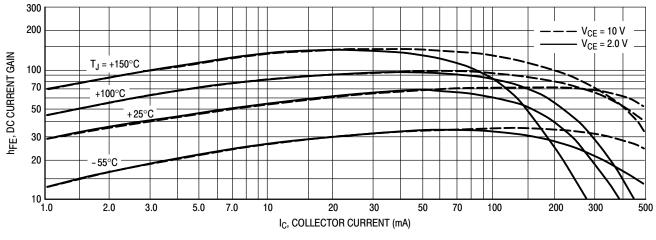


Figure 4. Current Gain

2N5655G, 2N5657G

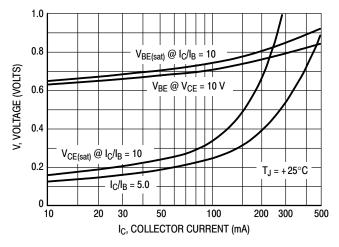
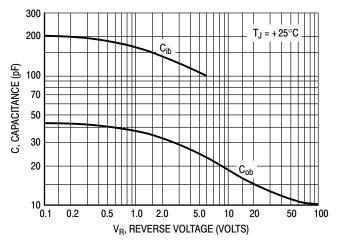
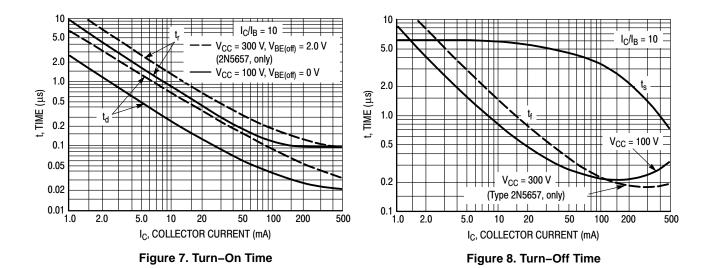


Figure 5. "On" Voltages

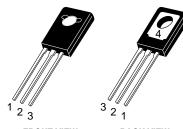






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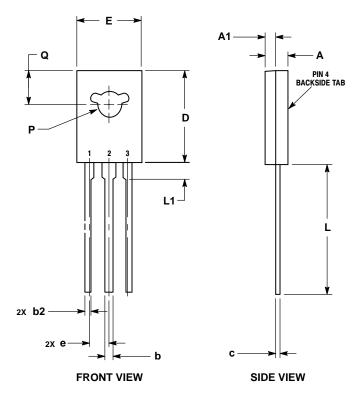
PACKAGE DIMENSIONS



TO-225 CASE 77-09 **ISSUE AC**

FRONT VIEW





NOTES: 1. DIMENSIONING AND TOLERANCING PER

ASME Y14.5M, 1994. 2. CONTROLLING DIMENSION: MILLIMETERS. 3. NUMBER AND SHAPE OF LUGS OPTIONAL.

	MILLIMETERS		
DIM	MIN	MAX	
Α	2.40	3.00	
A1	1.00	1.50	
b	0.60	0.90	
b2	0.51	0.88	
C	0.39	0.63	
D	10.60	11.10	
Е	7.40	7.80	
е	2.04	2.54	
L	14.50	16.63	
L1	1.27	2.54	
Р	2.90	3.30	
Q	3.80	4.20	
	1. EMI	TTER LECTOR	

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